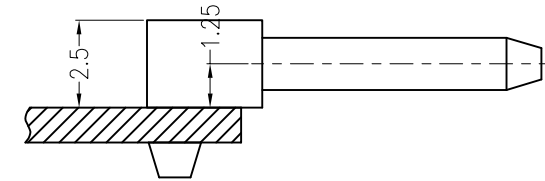
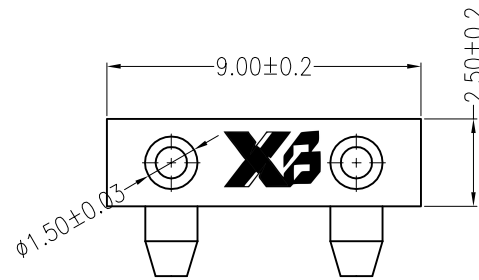
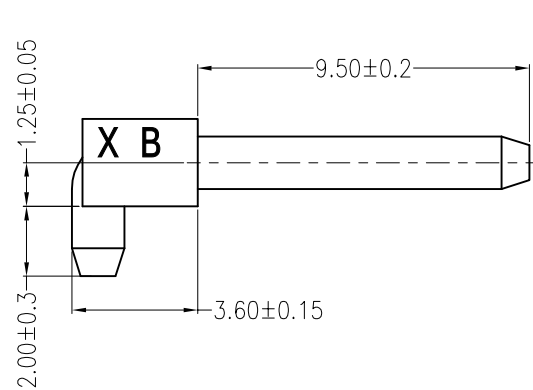


REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	王启生	2014.12.15



Assembly Layout

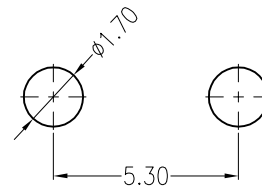
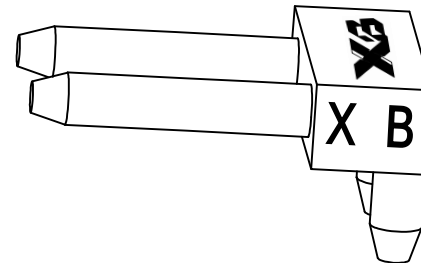
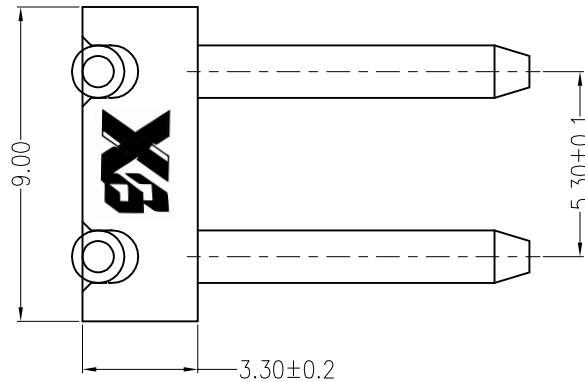
主要技术参数 Main Specifications

线 数 (Poles): 02
 接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
 绝缘电阻 (Insulation resistance): $\geq 1000\text{M}\Omega$
 额定电压 (Rated voltage): 250V AC DC
 额定电流 (Rated current): 3.0A AC DC
 耐 电 压 (Withstand Voltage): 1000V AC/minute
 温度范围 (Temperature Range): $-40^{\circ}\text{C} \sim +110^{\circ}\text{C}$

ORDER INFORMATION:

XB-L018D-02-B3MG-PX

PART No.	PACKAGING:
No. FOR CIRCUITS:	P=PE
02	
PLASTIC MATERIAL:	PLATING:
B3M=PA46 (BEIGE)	G=Ni



Mating PCB detail

C				
B	CONTACT	2 PCS	Brass	Ni-plated
A	PEDESTAL	1 PCS	PA46	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
东莞市溪榜电子有限公司 Switch Connector DONG GUAN XI BANG ELECTRONICS CO., LTD				
TITLE: -				5.3mmPITCH 90°WAFER DIP TYPE
X.±0.5	X.±5°	USE:	PART NO.: L018D-02-B3MG-P	
.X±0.3	.X±2°	CUSTOMER		
.XX±0.25	.XX±1°	APPD: 邵敬和		
--	--	CHKD: 田 峰	DWG NO.: GCCP-0035	
		UNITS: mm	DR: 蒋建银	SCALE 1 : 1
				SHEET 1 / 1